

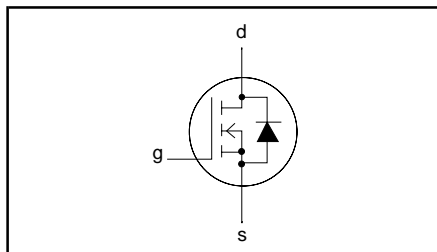
N-channel TrenchMOS™ transistor

**PHP27NQ10T, PHB27NQ10T
PHD27NQ10T**

FEATURES

- 'Trench' technology
- Low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

| |
|-------------------------------------|
| $V_{DSS} = 100\text{ V}$ |
| $I_D = 28\text{ A}$ |
| $R_{DS(ON)} \leq 50\text{ m}\Omega$ |

GENERAL DESCRIPTION

N-channel enhancement mode field-effect power transistor in a plastic envelope using 'trench' technology.

Applications:-

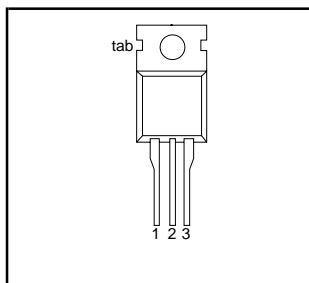
- d.c. to d.c. converters
- switched mode power supplies

The PHP27NQ10T is supplied in the SOT78 (TO220AB) conventional leaded package.
The PHB27NQ10T is supplied in the SOT404 (D²PAK) surface mounting package.
The PHD27NQ10T is supplied in the SOT428 (DPAK) surface mounting package.

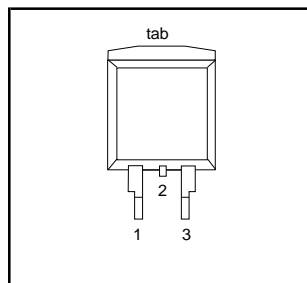
PINNING

| PIN | DESCRIPTION |
|-----|--------------------|
| 1 | gate |
| 2 | drain ¹ |
| 3 | source |
| tab | drain |

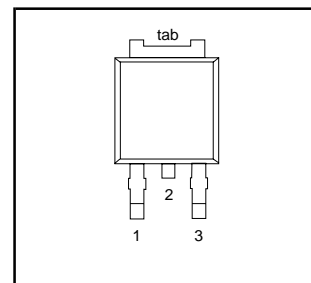
SOT78 (TO220AB)



SOT404 (D²PAK)



SOT428 (DPAK)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|----------------|--|--|------|----------|------------------|
| V_{DSS} | Drain-source voltage | $T_j = 25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$ | - | 100 | V |
| V_{DGR} | Drain-gate voltage | $T_j = 25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$; $R_{GS} = 20\text{ k}\Omega$ | - | 100 | V |
| V_{GS} | Gate-source voltage | | - | ± 20 | V |
| I_D | Continuous drain current | $T_{mb} = 25\text{ }^\circ\text{C}$; $V_{GS} = 10\text{ V}$ | - | 28 | A |
| | | $T_{mb} = 100\text{ }^\circ\text{C}$; $V_{GS} = 10\text{ V}$ | - | 20 | A |
| I_{DM} | Pulsed drain current | $T_{mb} = 25\text{ }^\circ\text{C}$ | - | 112 | A |
| P_D | Total power dissipation | $T_{mb} = 25\text{ }^\circ\text{C}$ | - | 107 | W |
| T_j, T_{stg} | Operating junction and storage temperature | | -55 | 175 | $^\circ\text{C}$ |

¹ It is not possible to make connection to pin:2 of the SOT404 or SOT428 packages.

N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T**AVALANCHE ENERGY LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|----------|---------------------------------------|---|------|------|------|
| E_{AS} | Non-repetitive avalanche energy | Unclamped inductive load, $I_{AS} = 20$ A; $t_p = 100$ μ s; T_j prior to avalanche = 25 °C; $V_{DD} \leq 25$ V; $R_{GS} = 50$ Ω ; $V_{GS} = 10$ V; refer to fig:15 | - | 128 | mJ |
| I_{AS} | Peak non-repetitive avalanche current | | - | 28 | A |

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------|--|--|------|------|------|------|
| $R_{th\ j-mb}$ | Thermal resistance junction to mounting base | | - | - | 1.4 | K/W |
| $R_{th\ j-a}$ | Thermal resistance junction to ambient | SOT78 package, in free air SOT404 & SOT428 packages, pcb mounted, minimum footprint | - | 60 | - | K/W |
| | | | - | 50 | - | K/W |

ELECTRICAL CHARACTERISTICS $T_j = 25$ °C unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|----------------------------------|--|-----------|------|------|--------------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0$ V; $I_D = 0.25$ mA; $T_j = -55$ °C | 100 89 | - | - | V V |
| $V_{GS(TO)}$ | Gate threshold voltage | $V_{DS} = V_{GS}$; $I_D = 1$ mA $T_j = 175$ °C $T_j = -55$ °C | 2 1 | 3 | 4 | V V V |
| $R_{DS(ON)}$ | Drain-source on-state resistance | $V_{GS} = 10$ V; $I_D = 14$ A $T_j = 175$ °C | - | 40 | 50 | m Ω m Ω |
| I_{GSS} | Gate source leakage current | $V_{GS} = \pm 20$ V; $V_{DS} = 0$ V | - | 10 | 100 | nA |
| I_{DSS} | Zero gate voltage drain current | $V_{DS} = 100$ V; $V_{GS} = 0$ V $T_j = 175$ °C | - | 0.05 | 10 | μ A μ A |
| $Q_{g(tot)}$ | Total gate charge | $I_D = 27$ A; $V_{DD} = 80$ V; $V_{GS} = 10$ V | - | 30 | - | nC |
| Q_{gs} | Gate-source charge | | - | 6 | - | nC |
| Q_{gd} | Gate-drain (Miller) charge | | - | 12 | - | nC |
| t_{don} | Turn-on delay time | $V_{DD} = 50$ V; $R_D = 1.8$ Ω ; $V_{GS} = 10$ V; $R_G = 5.6$ Ω Resistive load | - | 12 | - | ns |
| t_r | Turn-on rise time | | - | 43 | - | ns |
| t_{doff} | Turn-off delay time | | - | 32 | - | ns |
| t_f | Turn-off fall time | | - | 24 | - | ns |
| L_d | Internal drain inductance | Measured tab to centre of die | - | 3.5 | - | nH |
| L_d | Internal drain inductance | Measured from drain lead to centre of die (SOT78 package only) | - | 4.5 | - | nH |
| L_s | Internal source inductance | Measured from source lead to source bond pad | - | 7.5 | - | nH |
| C_{iss} | Input capacitance | $V_{GS} = 0$ V; $V_{DS} = 25$ V; $f = 1$ MHz | - | 1240 | - | pF |
| C_{oss} | Output capacitance | | - | 172 | - | pF |
| C_{rss} | Feedback capacitance | | - | 100 | - | pF |

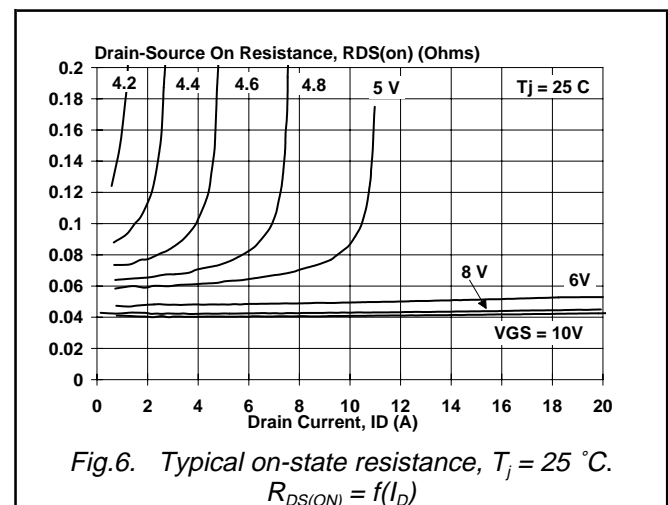
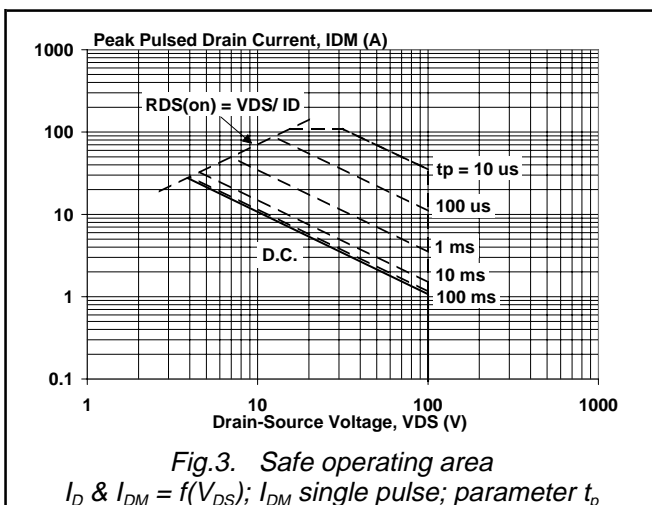
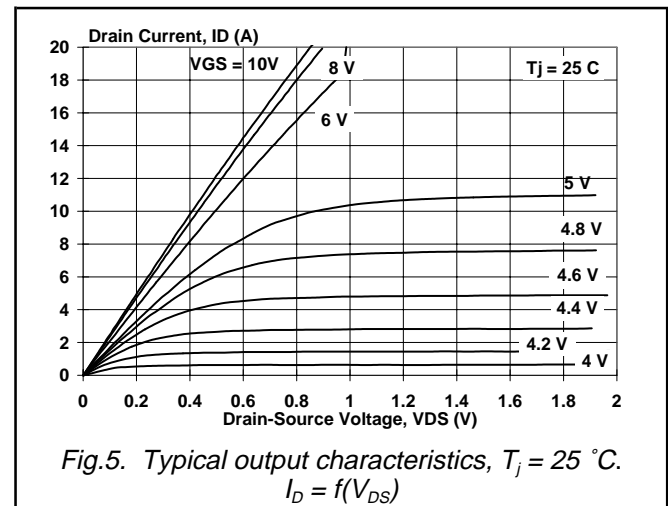
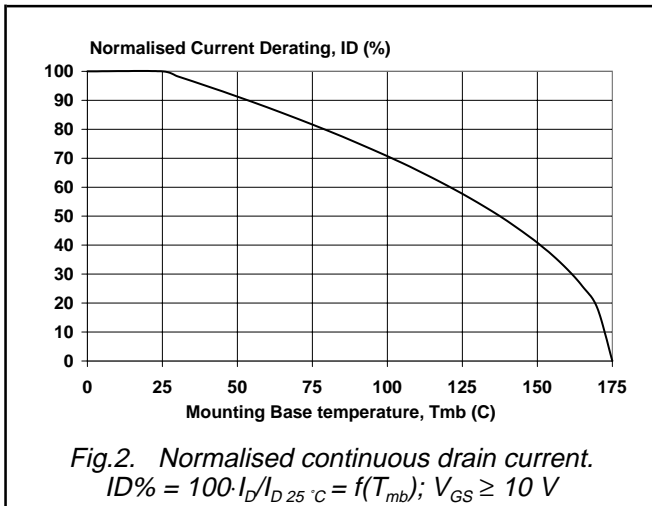
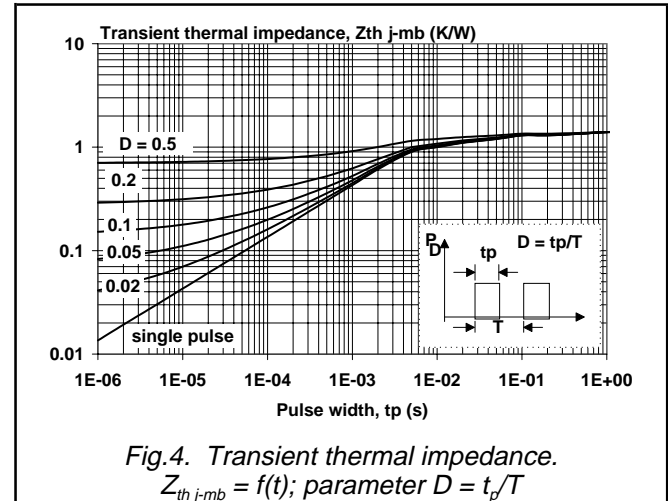
N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T**REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS** $T_j = 25^\circ\text{C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------|--|---|------|------|------|------|
| I_S | Continuous source current (body diode) | | - | - | 28 | A |
| I_{SM} | Pulsed source current (body diode) | | - | - | 112 | A |
| V_{SD} | Diode forward voltage | $I_F = 14\text{ A}; V_{GS} = 0\text{ V}$ | - | 0.9 | 1.2 | V |
| t_{rr} | Reverse recovery time | $I_F = 14\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s};$ $V_{GS} = 0\text{ V}; V_R = 25\text{ V}$ | - | 60 | - | ns |
| Q_{rr} | Reverse recovery charge | | - | 160 | - | nC |

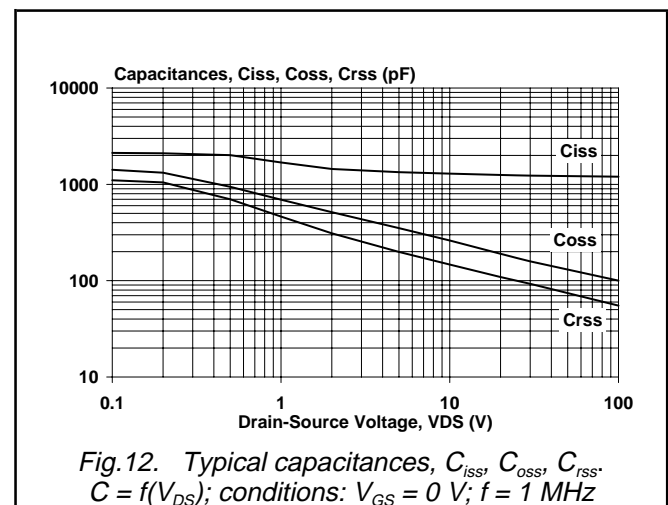
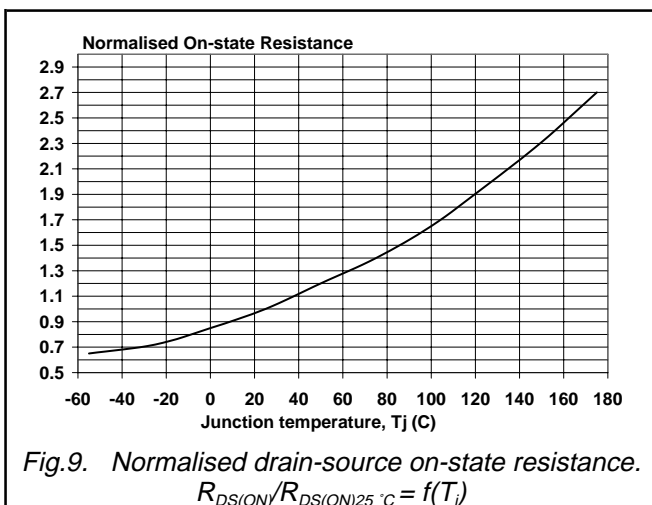
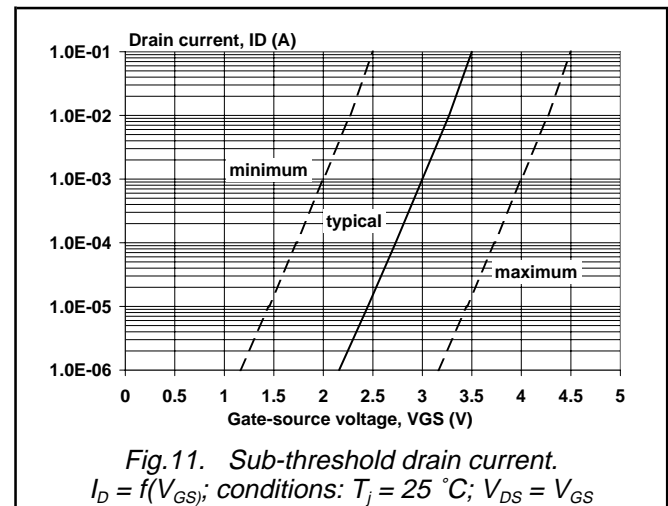
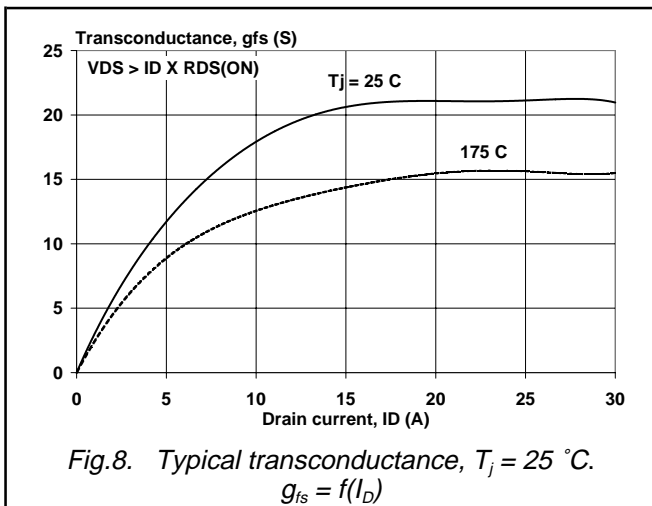
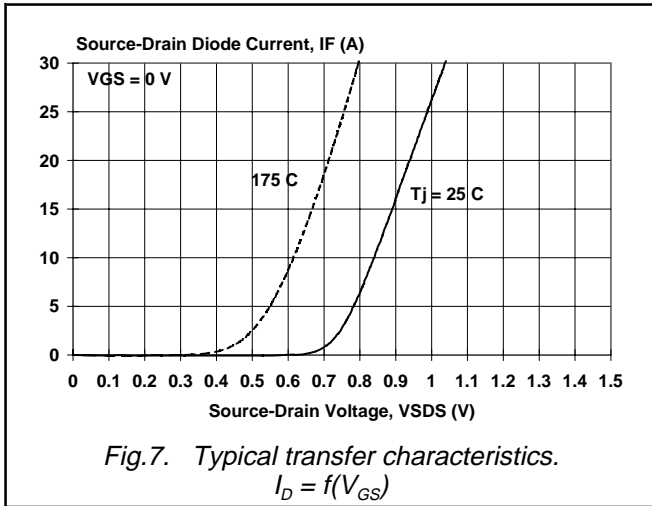
N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T



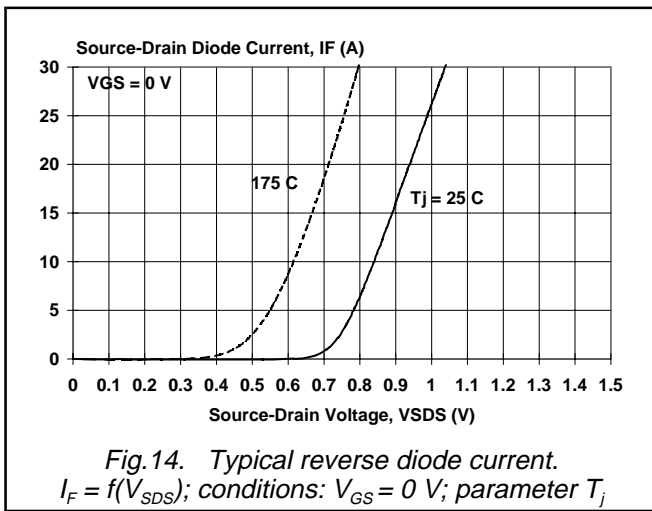
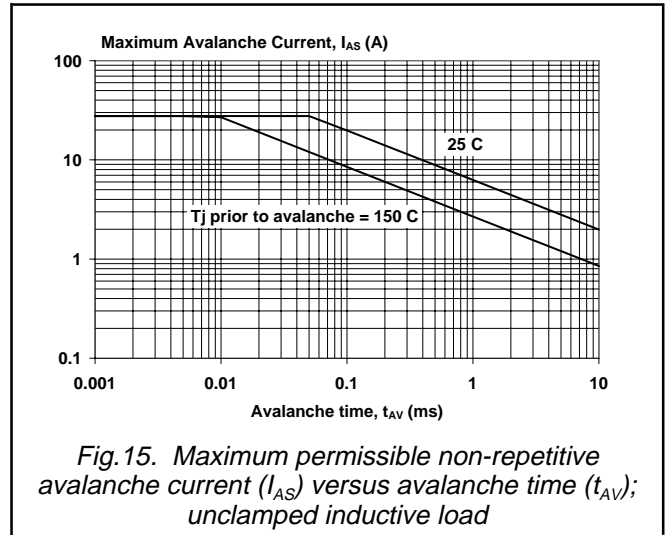
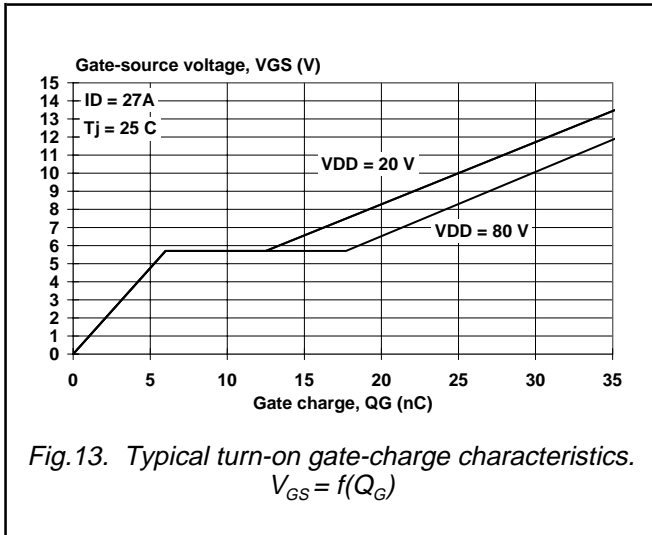
N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T



N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T



N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T

MECHANICAL DATA

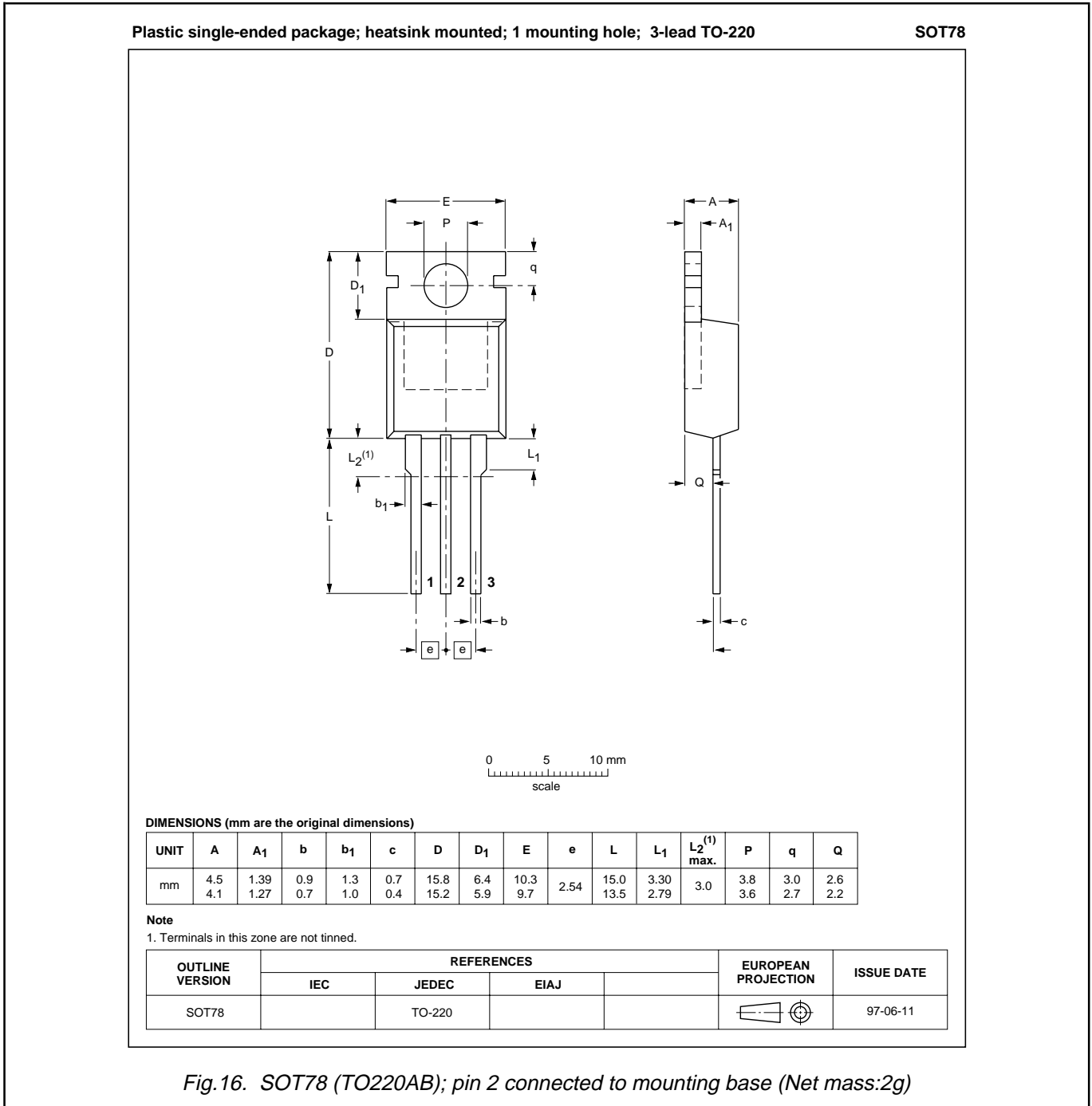


Fig. 16. SOT78 (TO220AB); pin 2 connected to mounting base (Net mass:2g)

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to mounting instructions for SOT78 (TO220AB) package.
3. Epoxy meets UL94 V0 at 1/8".

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MECHANICAL DATA

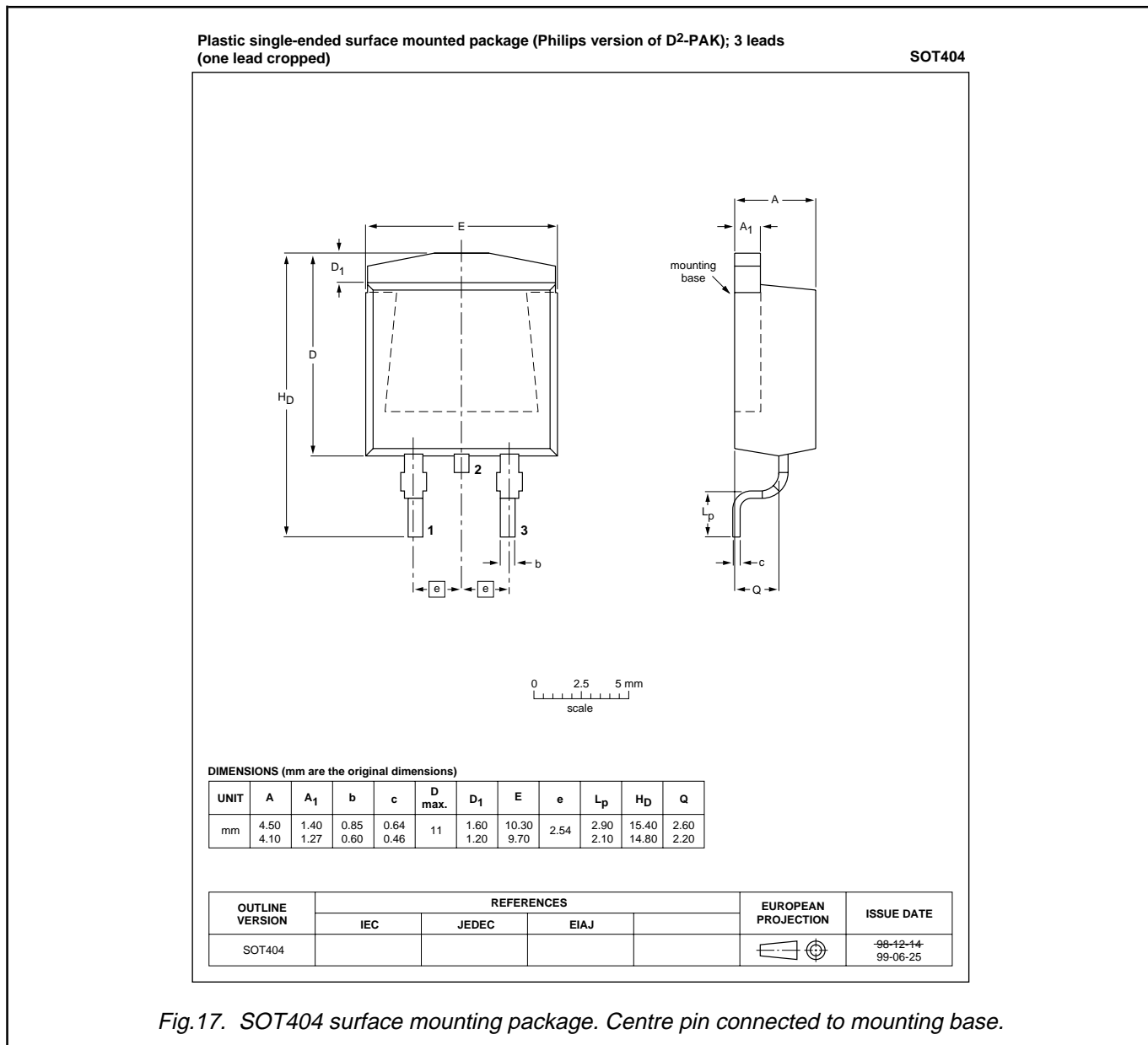


Fig.17. SOT404 surface mounting package. Centre pin connected to mounting base.

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

N-channel TrenchMOS™ transistor

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MOUNTING INSTRUCTIONS

Dimensions in mm

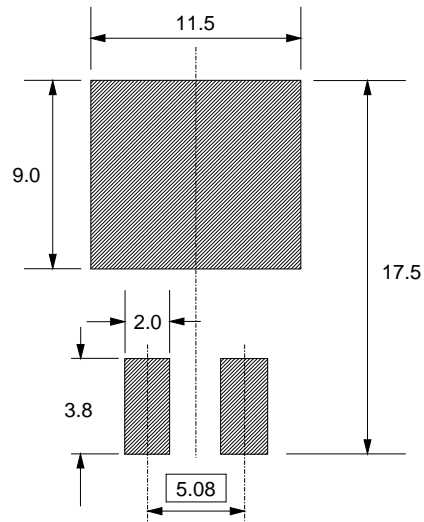


Fig.18. SOT404 : soldering pattern for surface mounting.

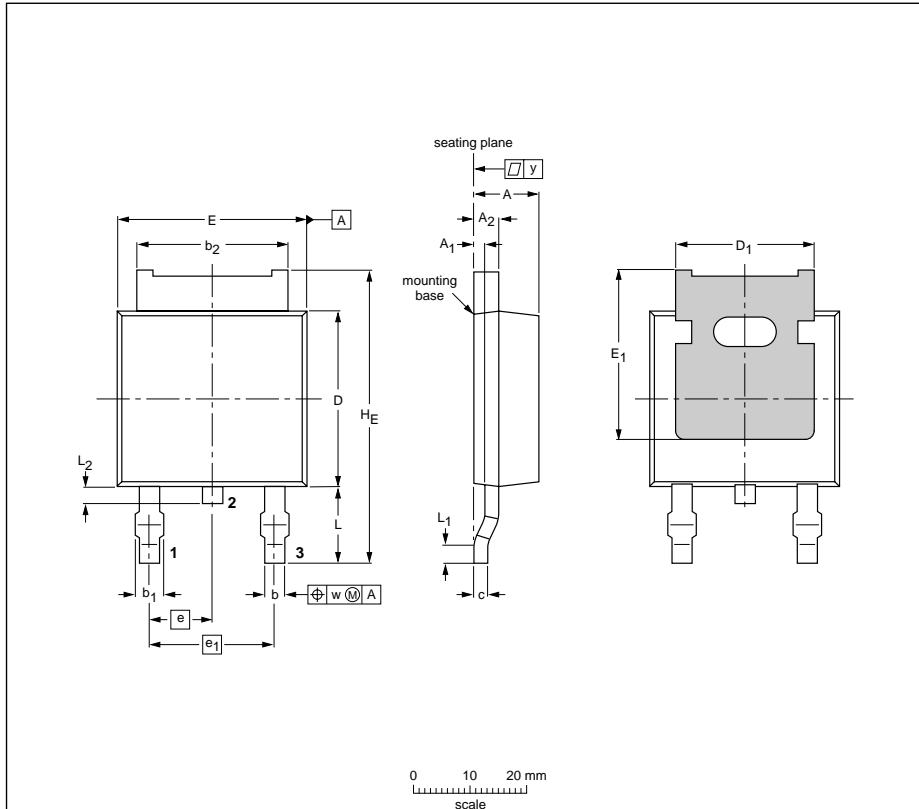
N-channel TrenchMOS™ transistor

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PHD27NQ10T

MECHANICAL DATA

Plastic single-ended surface mounted package (Philips version of D-PAK); 3 leads
(one lead cropped)

SOT428



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ ⁽¹⁾ | A ₂ | b | b ₁ max. | b ₂ | c | D max. | D ₁ max. | E max. | E ₁ min. | e | e ₁ | H _E max. | L | L ₁ min. | L ₂ | w | y max. |
|------|--------------|-------------------------------|----------------|--------------|---------------------|----------------|------------|--------------|---------------------|--------------|---------------------|-------|----------------|---------------------|--------------|---------------------|----------------|-----|--------|
| mm | 2.38 2.22 | 0.65 0.45 | 0.89 0.71 | 0.89 0.71 | 1.1 0.9 | 5.36 5.26 | 0.4 0.2 | 6.22 5.98 | 4.81 4.45 | 6.73 6.47 | 4.0 | 2.285 | 4.57 | 10.4 9.6 | 2.95 2.55 | 0.5 | 0.7 0.5 | 0.2 | 0.2 |

Note

1. Measured from heatsink back to lead.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|------|--|---------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT428 | | | | | | 98-04-07 |

Fig.19. SOT428 surface mounting package. Centre pin connected to mounting base.

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T

MOUNTING INSTRUCTIONS

Dimensions in mm

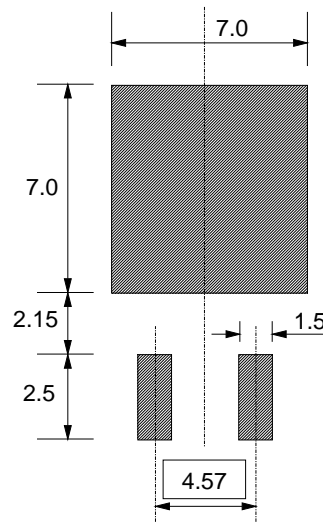


Fig.20. SOT428 : soldering pattern for surface mounting.

N-channel TrenchMOS™ transistor

PHP27NQ10T, PHB27NQ10T
PHD27NQ10T**DEFINITIONS**

| | |
|--|---|
| Data sheet status | |
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |
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